belkin

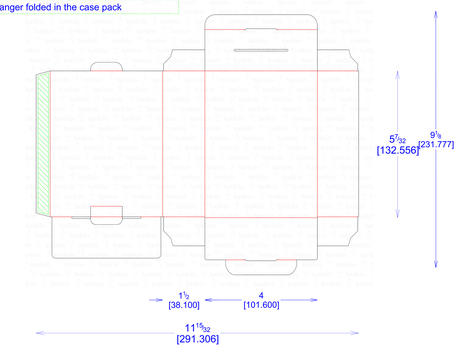
Die Line File: IDL_F7U088_WIN124 BOOTSUP 10W WIRELESS CHARGING PAD WITHOUT PSU

Artwork File:

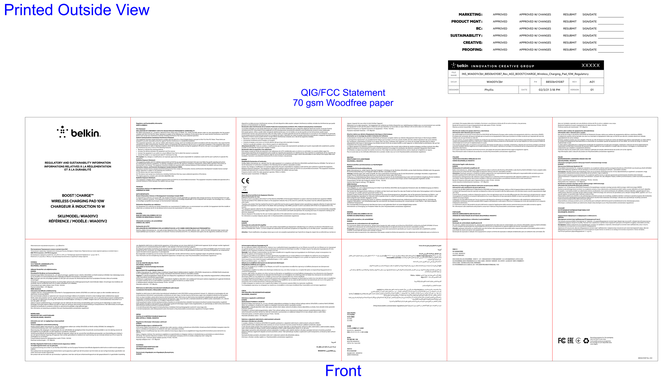
REV 0 00

DIE LAYOUT

BOM F7U088	P#
Outer box	Refer Artwork
PET Tray ROW:	7100-01128 Rev A00
QIG/FCC Statement Card	Refer Artwork
Wafer seal (2pcs)	25 mm
Hanger folded in the case pack	

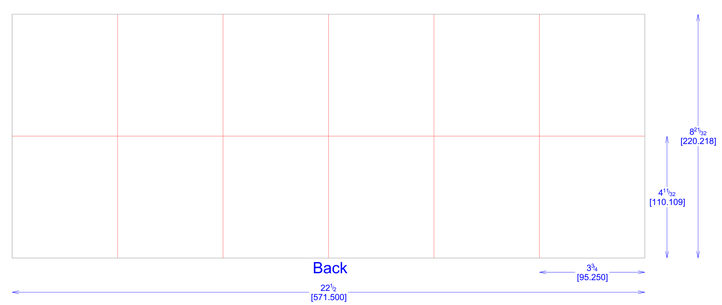


Printed Outside View



QIG/FCC Statement
70 gsm Woodfree paper

Front



Back

Business Unit: Core

Program Manager:

Packaging Engineer: Matthew Duffy

Retail Outside Dimension (Including Hang Tab)

L x W x D (in):

L x W x D (mm):

DIE/MATERIAL SPECS:

Material: 350gsm C1S SBS (20pt)

Blank Size (in): 11+15/32 x 9+1/4

Blank Size (mm): 291.306 x 234.950

This dieline works for following skus (if any):

dq, ja, th, tt, yj, yz, zh, jc, kr, vf, zb, pb, au, bgdr, hk, sa, uk, af, my

Unit: IN/MM

Side Shown: PRINT SIDE

Flute/Grain: horizontal

Tolerance:+/- 1/32" - 0.8mm

Drawing Scale 1:1

RELEASE DATE: 12/12/2018

DIELINE:

Intermediate

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PRINT SPECS:

Color Plates:

Finish:

Notes:

DO NOT PRINT
DIE LINES, PRINTERS NOTES